

# NPN & PNP General Purpose Amplifier

This complementary device is designed for use as a general purpose amplifier and switch The useful dynamic range extends to 100 mA as a switch and 100 MHz as an amplifier. Sourced from Process 23 and 66. See FFB3904 (NPN) and FFB3906 (PNP) for characteristics.

#### Absolute Maximum Ratings\* T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CEO</sub>	Collector-Emitter Voltage	40	V
V <sub>CBO</sub>	Collector-Base Voltage	40	V
V <sub>EBO</sub>	Emitter-Base Voltage	5.0	V
I <sub>C</sub>	Collector Current - Continuous	200	mA
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

\*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.

These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
All voltages (V) and currents (A) are negative polarity for PNP transistors.

## Thermal Characteristics

Symbol	Characteristic	Max Un		Units
		FFB3946	FMB3946	
PD	Total Device Dissipation	300	700	mW
	Derate above 25°C	2.4	5.6	mW/∘C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	415	180	°C/W

 $T_{a} = 25^{\circ}C$  unless otherwise noted

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## NPN & PNP General Purpose Amplifier (c

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Symbol Devemotor	Test Conditions	N/1:
<b>Electrical Characteristics</b>	$T_A = 25^{\circ}C$ unless otherwise noted	

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units

## **OFF CHARACTERISTICS**

V <sub>(BR)CEO</sub>	Collector-Emitter Breakdown Voltage	$I_{C} = 10 \text{ mA}, I_{B} = 0$	40		V
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	$I_{C} = 10 \ \mu A, \ I_{E} = 0$	40		V
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	$I_{E} = 10 \ \mu A, \ I_{C} = 0$	5.0		V
I <sub>CBO</sub>	Collector Cutoff Current	$V_{CB} = 30 \text{ V}, I_E = 0$		50	nA
I <sub>EBO</sub>	Emitter Cutoff Current	$V_{EB} = 4.0 \text{ V}, I_C = 0$		50	nA

## **ON CHARACTERISTICS**

h <sub>FE</sub>	DC Current Gain		40 70 100 60 30	300	
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	$I_{\rm C} = 10$ mA, $I_{\rm B} = 1.0$ mA		0.25	V
V <sub>BE(sat)</sub>	Base-Emitter Saturation Voltage	$I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 1.0 mA		0.9	V

## SMALL SIGNAL CHARACTERISTICS

f <sub>T</sub>	Current Gain - Bandwidth Product	$I_{C} = 10 \text{ mA}, V_{CE} = 20 \text{ V},$ f = 100 MHz	200	MHz
Cobo	Output Capacitance	$V_{CB} = 5.0 \text{ V}, \text{ f} = 100 \text{ kHz}$	4.5	pF
C <sub>ibo</sub>	Input Capacitance	$V_{CB} = 5.0 \text{ V}, \text{ f} = 100 \text{ kHz}$	10	pF

 $\ensuremath{\textbf{NOTE:}}\xspace$  All voltages (V) and currents (A) are negative polarity for PNP transistors.

FFB3946 / FMB3946

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